<table>
<thead>
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<th>Number</th>
<th>Description</th>
<th>Layer</th>
<th>Color</th>
<th>Line Type</th>
<th>Note</th>
</tr>
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<tr>
<td>A</td>
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<td>Black</td>
<td>Solid</td>
<td></td>
</tr>
<tr>
<td>B</td>
<td>2.0</td>
<td>Middle</td>
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<td>Solid</td>
<td></td>
</tr>
<tr>
<td>C</td>
<td>3.0</td>
<td>Bottom</td>
<td>Black</td>
<td>Solid</td>
<td></td>
</tr>
</tbody>
</table>

**NOTICE:**

- This is a technical drawing for a specific project.
- The layers are for Top, Middle, and Bottom views.
- The color used is Black for Solid lines.
- The notes are left blank for further details.

**Teaching Instruments:**

- All annotations are visible in the drawing for easy reference.

**Additional Information:**

- The drawing is generated on 11-8-2017 at 4:26:13 PM by [Author].
- The drawing is specific to the project titled [Project Title].
- The layers and notes are used for clarity and organization in the project.
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